Split T-Type NPC Power Module

1200 V, 160 A IGBT, 650 V, 100 A IGBT

The NXH160T120L2Q2F2S1G is a power module containing a

Table 1. ABSOLUTE MAXIMUM RATINGS (Note 1) T_{.1} = 25°C unless otherwise noted

Rating	Symbol	Value	Unit		
HALF BRIDGE IGBT					
Collector-Emitter Voltage	V _{CES}	1200	V		
Gate-Emitter Voltage	V _{GE}	±20	V		
Continuous Collector Current @ T _h = 80°C (T _J = 175°C)	Ic	181	А		
Pulsed Collector Current (T _J = 175°C)	I _{Cpulse}	543	А		
Maximum Power Dissipation @ T _h = 80°C (T _J = 175°C)	P _{tot}		-		

Table 1. ABSOLUTE MAXIMUM RATINGS (Note 1) T_{.I} = 25°C unless otherwise noted

Symbol	Value	Unit	
T_JMAX	150	°C	
T _{stg}	-40 to 125		
V _{is}	3000	V_{RMS}	
	12.7	mm	
	T _{JMAX}	T _{JMAX} 150 T _{stg} -40 to 125 V _{is} 3000	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Refer to ELECTRICAL CHARACTERISTICS, RECOMMENDED OPERATING RANGES and/or APPLICATION INFORMATION for Safe

Table 2. RECOMMENDED OPERATING RANGES

Rating	Symbol	Min	Max	Unit
Module Operating Junction Temperature	T_J	-40	(T _{jmax} -25)	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

Table 3. ELECTRICAL CHARACTERISTICS $T_J = 25^{\circ}C$ unless otherwise noted

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit	
HALF BRIDGE IGBT CHARACTERISTICS							
Collector-Emitter Cutoff Current	V _{GE} = 0 V, V _{CE} = 1200 V	I _{CES}	_	_	500	μ Оре	307 Eerf6t1@:9(213.e k

Operating parameters.

Table 3. ELECTRICAL CHARACTERISTICS $\rm T_J = 25^{\circ}C$ unless otherwise noted

Parameter Symbol Min Typ Max Unit

Table 3. ELECTRICAL CHARACTERISTICS $T_J = 25\,^{\circ}\text{C}$ unless otherwise noted

Parameter Max Unit

TYPICAL CHARACTERISTICS	Half Bridge IGBT and Neutral Point Diode

TYPICAL CHARACTERISTICS Half Bridge IGBT and Neutral Point Diode

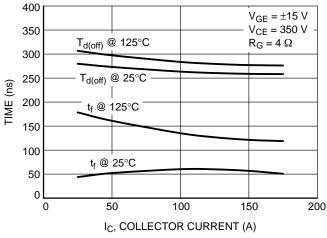


Figure 7. Typical Turn Off Time vs. IC

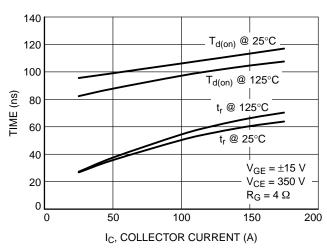


Figure 8. Typical Turn On Time vs. IC

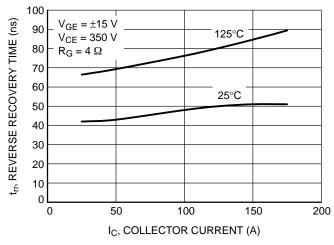


Figure 9. Typical Reverse Recovery Time vs. IC

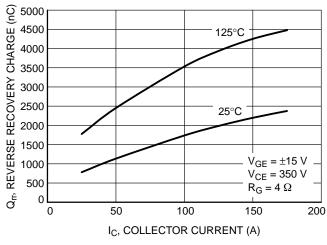


Figure 10. Typical Reverse Recovery Charge vs. IC

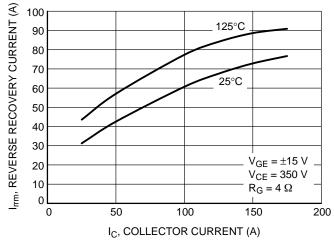


Figure 11. Typical Reverse Recovery Peak Current vs. IC

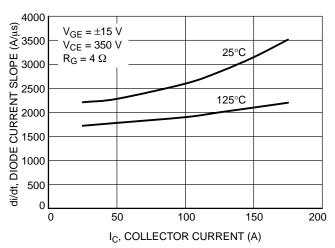
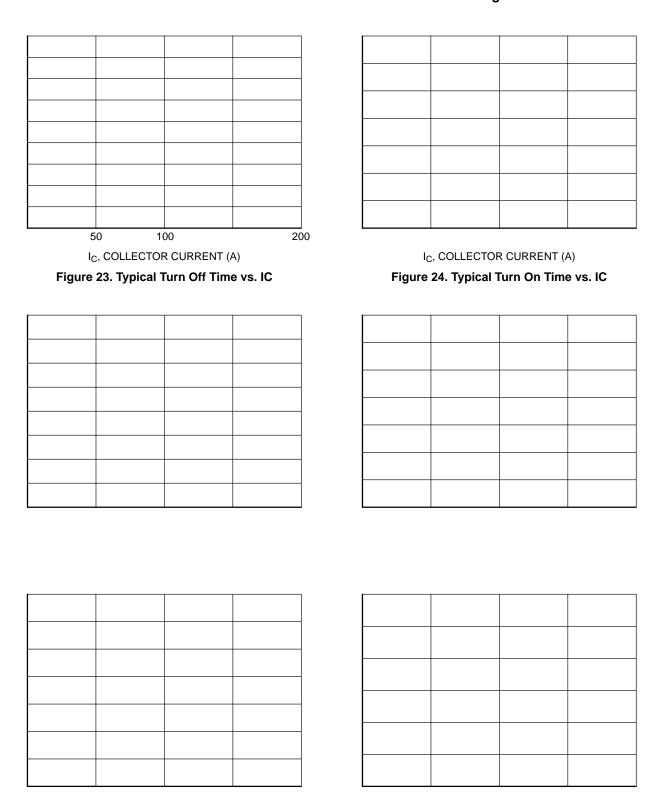
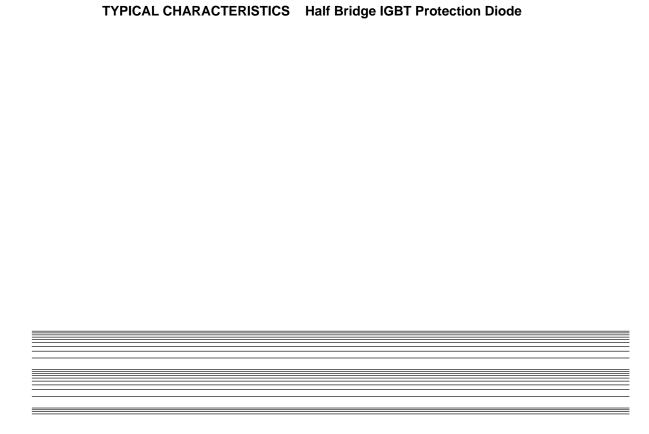


Figure 12. Typical Diode Current Slope vs. IC

TYPICAL CHARACTERISTICS Neutral Point IGBT and Half Bridge Diode





TYPICAL CHARACTERISTICS Neutral Point IGBT Protection Diode

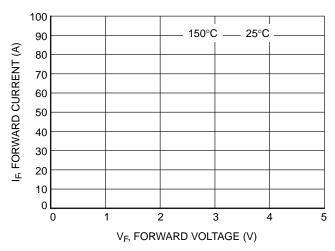
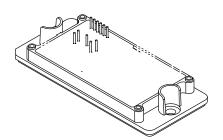


Figure 35. Diode Forward Characteristic



PIM56, 93x47 (SOLDER PIN) CASE 180AK ISSUE B

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